



MMBD4448

SURFACE MOUNT SWITCHING DIODE

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant
- "Green' Device (Notes 1 and 2)

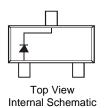
Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)





Top View



Ordering Information (Note 3)

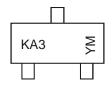
ĺ	Part Number	Case	Packaging
	MMBD4448-7-F	SOT-23	3000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Product manufactured with Date Code V9(week 34, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



KA3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002)M = Month (ex: 9 = September)

Date Code Key

Year	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	K	L	М	N	Р	R	S	Т	U	V	W	Χ	Υ	Z	Α	В	С
Month	Jan		Feb	Mar	Α	pr	May	Jur	1	Jul	Aug	S	ер	Oct	No	v	Dec
Code	1		2	3	4	4	5	6		7	8	,	9	0	N		D

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Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RM} V _{RWM} V _R	75	V
RMS Reverse Voltage		$V_{R(RMS)}$	53	V
Forward Continuous Current (Note 4)		I _{FM}	500	mA
Average Rectified Output Current (Note 4)		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	IFSM	4.0 1.0	А

Thermal Characteristics

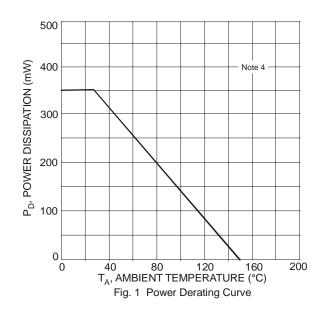
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P_{D}	350	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	357	°C/W
Operating and Storage Temperature Range	T_J,T_STG	-65 to +150	°C

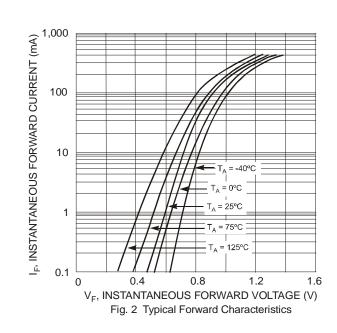
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	75	1	V	$I_R = 2.5 \mu A$
	V _F	0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage		_	0.855		$I_F = 10mA$
Forward Voltage		_	1.0		$I_F = 100 \text{mA}$
			1.25		$I_F = 150 \text{mA}$
	I _R		2.5	μΑ	V _R = 75V
Reverse Current (Note 5)			50	μΑ μΑ nA	$V_R = 75V, T_J = 150^{\circ}C$
Reverse Current (Note 5)		ir —	30		$V_R = 25V, T_J = 150^{\circ}C$
			25		$V_R = 20V$
Total Capacitance	C _T	_	4.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time			4.0	ns	$I_F = I_R = 10 \text{mA},$
verse recovery rime	t _{rr}				$I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100\Omega$

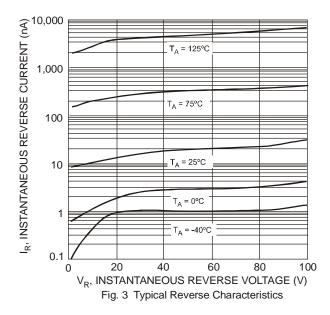
Notes: 4. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.

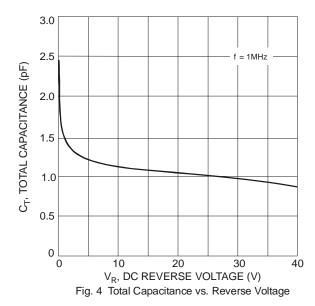
5. Short duration pulse test used to minimize self-heating effect.



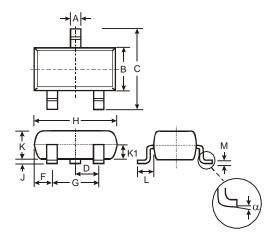






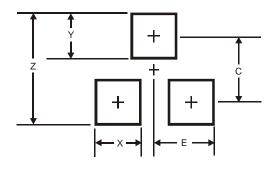


Package Outline Dimensions



SOT-23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
C	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Η	2.80	3.00	2.90					
7	0.013	0.10	0.05					
K	0.903	1.10	1.00					
K1	-	-	0.400					
L	0.45	0.61	0.55					
М	0.085	0.18	0.11					
α	0°	8°	-					
All Dimensions in mm								

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Υ	0.9
С	2.0
E	1.35



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